

	Type	L #	Hits	Search T xt	DB	Tim Stamp	C mm n ts
1	BRS	L1	952109	Cu r copper r Cu-all y r copper-alloy or Cu-line or copper-line or Cu-interconnect\$4 or copper-interconnect\$4	USPA T; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/06/04 14:07	
4	BRS	L16	1424	1 same (slot or cut or split or open\$4) same (stress or strain or stress-relief or strain-relief)	USPA T; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/06/04 14:35	
5	BRS	L23	396	16 and semiconductor	USPA T; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/06/04 14:37	

	Type	L #	Hits	Search T xt	DB	Tim Stamp	Comm n ts
1	BRS	L1	952109	Cu r pp r r Cu-alloy r copper-alloy or Cu-line or copper-line or Cu-interconnect\$4 or copper-interconnect\$4	USPA T; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/06/04 14:07	
3	BRS	L9	112	1 near20 (slot or cut or split or open\$4) near20 (stress or strain or stress-relief or strain-relief)	USPA T; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/06/04 14:12	